



S/N 10/656,968

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Daniel P. Carter et al.

Examiner: Essama Omgba

Serial No.: 10/656,968

Group Art Unit: 3726

Filed: September 5, 2003

Docket No.: 884.467US2

Title: Electronic Assemblies With High Capacity Heat
Sinks and Methods of Manufacture

Assignee: Intel Corporation

Customer Number: 21186

RESPONSE UNDER 37 CFR § 1.111

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

This responds to the Office Action mailed on October 24, 2005. Please consider the remarks as follows.